L Number	Hits	Search Text	DB	Time stamp
18	10	((resist or photoresist or polyimide or	USPAT;	2003/10/07 13:35
		benzocyclobutene or benzo adj cyclobutene	US-PGPUB;	
,		or benzocyclo adj butene or benzo adj	EPO; JPO;	
		cyclo adj butene or BCB) same (transition	IBM_TDB	ļ
		adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or		
		heat\$3 or temperature or degrees or		
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or		
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
		((semiconduct\$3 or wafer or silicon or		
		"Si").ti,ab. and (resist or photoresist)		
		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		
		adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		
1.0	0.0	(228/164,203,232,246,262.9).ccls.	HCDATT.	2003/10/07 13:36
19	82	((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene	USPAT; US-PGPUB;	2003/10/07 13:36
		or benzocyclo adj butene or benzo adj	EPO; JPO;	İ
		cyclo adj butene or BCB) same (transition	IBM TDB	
		adj temperature or "Tg" or "T.sub.g" or	-	
ı		degrees) and (solder same (melt\$3 or		
		heat\$3 or temperature or degrees or		
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and		1
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
		(resist or photoresist))) not	1	
		(((semiconduct\$3 or wafer or silicon or		
		"Si").ti,ab. and (resist or photoresist)		
		same solder\$3 near3 (ball\$3 or bump\$3)		1
		same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo]
		adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		
		(438/108,115,612-615,660,694).ccls.		
20	40	((100100 01 priore) 1 pr-1 minute 1	USPAT;	2003/10/07 13:40
		benzocyclobutene or benzo adj cyclobutene	US-PGPUB;	
		or benzocyclo adj butene or benzo adj	EPO; JPO;	
		cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or	IBM_TDB	
		degrees) and (solder same (melt\$3 or		
		heat\$3 or temperature or degrees or		
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or		
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not		
		(((semiconduct\$3 or wafer or silicon or		
		"Si").ti,ab. and (resist or photoresist)		
		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		
		adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and		
		(430/311,313-314,316-319).ccls.		
		(400/011,010-014,010-015).CC18.	l	L,

Page 1

21	24	((resist or photoresist or polyimide or	USPAT;	2003/10/07	13:40
21	2.1	benzocyclobutene or benzo adj cyclobutene	US-PGPUB;		
		or benzocyclo adj butene or benzo adj	EPO; JPO;		
		cyclo adj butene or BCB) same (transition	IBM TDB		
		cyclo adj butene of Bob, same (clansicion	1017_100		
		adj temperature or "Tg" or "T.sub.g" or			
İ		degrees) and (solder same (melt\$3 or			
		heat\$3 or temperature or degrees or			
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or			
1		bump\$3) same (heat\$3 or thermal\$3 or			
		temperature or degree)) and			
		((benzocyclobutene or benzo adj			
		cyclobutene or benzocyclo adj butene or			
		benzo adj cyclo adj butene or BCB) same			
		(resist or photoresist))) not			
		(((semiconduct\$3 or wafer or silicon or			
		"Si").ti,ab. and (resist or photoresist)			
		same solder\$3 near3 (ball\$3 or bump\$3)			
		same (heat\$3 or thermal\$3 or temperature			
		or degree)) and (benzocyclobutene or benzo			
		adj cyclobutene or benzocyclo adj butene	-		
		or BCB) same (resist or photoresist))) and			
		(430/329-330).ccls.		L	

2	136	(((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene	USPAT; US-PGPUB;	2003/10/07 13:
		or benzocyclo adj butene or benzo adj	EPO; JPO;	
	i		IBM TDB	
	!	cyclo adj butene or BCB) same (transition	TDM_TDB	1
		adj temperature or "Tg" or "T.sub.g" or		
		degrees) and (solder same (melt\$3 or		
	ĺ	heat\$3 or temperature or degrees or		
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or		
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
		(resist or photoresist))) not		
		(((semiconduct\$3 or wafer or silicon or		
		"Si").ti,ab. and (resist or photoresist)		
		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		
		adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		1
		(228/164,203,232,246,262.9).ccls.) or		
		(((resist or photoresist or polyimide or		
		benzocyclobutene or benzo adj cyclobutene		1
		or benzocyclo adj butene or benzo adj		
		cyclo adj butene or BCB) same (transition	1	
		adj temperature or "Tg" or "T.sub.g" or		
		degrees) and (solder same (melt\$3 or		
		heat\$3 or temperature or degrees or		1
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or		
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or	1	
		benzo adj cyclo adj butene or BCB) same	İ	
		(resist or photoresist))) not		
		(((semiconduct\$3 or wafer or silicon or		
		"Si").ti,ab. and (resist or photoresist)		-
		same solder\$3 near3 (ball\$3 or bump\$3)		
	1	same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		
	1	adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		
		(438/108,115,612-615,660,694).ccls.) or		
]	(((resist or photoresist or polyimide or		
	İ	benzocyclobutene or benzo adj cyclobutene	ļ	
		or benzocyclo adj butene or benzo adj		
		cyclo adj butene or BCB) same (transition		
		adj temperature or "Tg" or "T.sub.g" or		
		degrees) and (solder same (melt\$3 or	1	
		heat\$3 or temperature or degrees or		
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or		
			· .	
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
		(resist or photoresist))) not		
		(((semiconduct\$3 or wafer or silicon or		
		"Si").ti,ab. and (resist or photoresist)		
		<pre>same solder\$3 near3 (ball\$3 or bump\$3)</pre>		
		same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		1 .
		adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		
		(430/311,313-314,316-319).ccls.) or		
		(((resist or photoresist or polyimide or	1	
		benzocyclobutene or benzo adj cyclobutene		
		or benzocyclo adj butene or benzo adj		
		cyclo adj butene or BCB) same (transition		
		adj temperature or "Tg" or "T.sub.g" or		
		degrees) and (solder same (melt\$3 or	<u> </u>	
rch His	tory 10	/he/alls 34 x0x0 t3:5mp284raturReagner 3degrees or		
APPG\0	ast\worken	cest/1005319060tsp((solder\$3 near3 (ball\$3 or		
127 E D / C C	JOC MOT VODE	bump\$3) same (heat\$3 or thermal\$3 or		
	1			

_	1	("20030134233").PN.	USPAT;	2003/10/03 09:19
			US-PGPUB; EPO; JPO;	
			IBM TDB	
_	289	(semiconduct\$3 or wafer or silicon or	USPAT;	2003/10/03 09:29
	200	"Si").ti,ab. and (resist or photoresist)	US-PGPUB;	
		same solder\$3 near3 (ball\$3 or bump\$3)	EPO; JPO;	
		same (heat\$3 or thermal\$3 or temperature	IBM_TDB	
1		or degree)	İ	
-	12	((semiconduct\$3 or wafer or silicon or	USPAT;	2003/10/03 13:36
}		"Si").ti,ab. and (resist or photoresist)	US-PGPUB;	
		same solder\$3 near3 (ball\$3 or bump\$3)	EPO; JPO;	
		same (heat\$3 or thermal\$3 or temperature	IBM_TDB	
		or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist)		
_	0	(solder\$3 near3 (ball\$3 or bump\$3) same	USPAT;	2003/10/03 13:46
		(heat\$3 or thermal\$3 or temperature or	US-PGPUB;	2000, 20, 00 20110
	ĺ	degree) same (benzocyclobutene or benzo	EPO; JPO;	
+		adj cyclobutene or benzocyclo adj butene	IBM TDB	
	1	or benzo adj cyclo adj butene or BCB) same	_	
		(resist or photoresist)) not		
		(((semiconduct\$3 or wafer or silicon or		
		"Si").ti,ab. and (resist or photoresist)		
	1	same solder\$3 near3 (ball\$3 or bump\$3)		
	1	same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))		
l_	17	(solder\$3 near3 (ball\$3 or bump\$3) same	USPAT;	2003/10/06 19:18
		(heat\$3 or thermal\$3 or temperature or	US-PGPUB;	
		degree)) and ((benzocyclobutene or benzo	EPO; JPO;	
		adj cyclobutene or benzocyclo adj butene	IBM TDB	
		or benzo adj cyclo adj butene or BCB) same	_	
		(resist or photoresist)) not		
		(((semiconduct\$3 or wafer or silicon or		
		"Si").ti,ab. and (resist or photoresist)		
		same solder\$3 near3 (ball\$3 or bump\$3)		
	!	same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene		
	1	or BCB) same (resist or photoresist))		
_	1455	(resist or photoresist or polyimide or	USPAT;	2003/10/06 19:36
	1	benzocyclobutene or benzo adj cyclobutene	US-PGPUB;	
	1	or benzocyclo adj butene or benzo adj	EPO; JPO;	
	!	cyclo adj butene or BCB) same (transition	IBM_TDB	
		adj temperature or "Tg" or "T.sub.g" or		
		degrees) and (solder same (melt\$3 or		
		heat\$3 or temperature or degrees or		
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or		
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
	1	(resist or photoresist))) not		
		(((semiconduct\$3 or wafer or silicon or		
1		"Si").ti,ab. and (resist or photoresist)		
		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		
	1	adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))		
	L	or pop) same (resist or buorotesisc))	l	<u> </u>

_	40	((resist or photoresist or polyimide or	USPAT;	2003/10/07 13:	39
		benzocyclobutene or benzo adj cyclobutene	US-PGPUB;		
		or benzocyclo adj butene or benzo adj	EPO; JPO;		
		cyclo adj butene or BCB) same (transition	IBM TDB		
}		adj temperature or "Tg" or "T.sub.g" or			
]	degrees) and (solder same (melt\$3 or	ļ		
		heat\$3 or temperature or degrees or			
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or			
]		bump\$3) same (heat\$3 or thermal\$3 or			
		temperature or degree)) and			
		((benzocyclobutene or benzo adj			
		cyclobutene or benzocyclo adj butene or			
		benzo adj cyclo adj butene or BCB) same			
		(resist or photoresist))) not			
		(((semiconduct\$3 or wafer or silicon or			
		"Si").ti,ab. and (resist or photoresist)			
1	i	same solder\$3 near3 (ball\$3 or bump\$3)			
		same (heat\$3 or thermal\$3 or temperature			
	i	or degree)) and (benzocyclobutene or benzo			
		adj cyclobutene or benzocyclo adj butene			
		or BCB) same (resist or photoresist))) and			
	1	(430/311,313-314,316-319).ccls.			
<u>_</u>	24	((resist or photoresist or polyimide or	USPAT;	2003/10/07 13:	40
		benzocyclobutene or benzo adj cyclobutene	US-PGPUB;		
		or benzocyclo adj butene or benzo adj	EPO; JPO;		
]		cyclo adj butene or BCB) same (transition	IBM TDB		
		adj temperature or "Tg" or "T.sub.g" or			
		degrees) and (solder same (melt\$3 or			
		heat\$3 or temperature or degrees or			
}		reflow\$3)) not ((solder\$3 near3 (ball\$3 or	ŀ		
		bump\$3) same (heat\$3 or thermal\$3 or			
		temperature or degree)) and			
	1	((benzocyclobutene or benzo adj			
		cyclobutene or benzocyclo adj butene or	}		
	1	benzo adj cyclo adj butene or BCB) same			
		(resist or photoresist))) not			
		(((semiconduct\$3 or wafer or silicon or			
		"Si").ti,ab. and (resist or photoresist)]		
		same solder\$3 near3 (ball\$3 or bump\$3)			
}		same (heat\$3 or thermal\$3 or temperature			
		or degree)) and (benzocyclobutene or benzo]		
		adj cyclobutene or benzocyclo adj butene			
		or BCB) same (resist or photoresist))) and			
		(430/329-330).ccls.]	

_	46	(((resist or photoresist or polyimide or	USPAT;	2003/10/07 13:36
		benzocyclobutene or benzo adj cyclobutene	US-PGPUB;	
		or benzocyclo adj butene or benzo adj	EPO; JPO;	
	}	cyclo adj butene or BCB) same (transition	IBM_TDB	
		adj temperature or "Tg" or "T.sub.g" or		
		degrees) and (solder same (melt\$3 or		
ĺ		heat\$3 or temperature or degrees or		
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or		
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
İ	Į	cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
		(resist or photoresist))) not		
		(((semiconduct\$3 or wafer or silicon or		
]	"Si").ti,ab. and (resist or photoresist)		
		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
	1	or degree)) and (benzocyclobutene or benzo		
	l	adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		
		(430/311,313-314,316-319).ccls.) or		
İ		(((resist or photoresist or polyimide or		
		benzocyclobutene or benzo adj cyclobutene		
		or benzocyclo adj butene or benzo adj		
		cyclo adj butene or BCB) same (transition		
		adj temperature or "Tg" or "T.sub.g" or		
		degrees) and (solder same (melt\$3 or		
		heat\$3 or temperature or degrees or		
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or	ĺ	
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
		(resist or photoresist))) not		
		(((semiconduct\$3 or wafer or silicon or		
		"Si").ti,ab. and (resist or photoresist)		
		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		
		adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		
		(430/329-330).ccls.)		
_	82	((resist or photoresist or polyimide or	USPAT;	2003/10/07 13:35
		benzocyclobutene or benzo adj cyclobutene	US-PGPUB;	
		or benzocyclo adj butene or benzo adj	EPO; JPO;	
	1	cyclo adj butene or BCB) same (transition	IBM TDB	
		adj temperature or "Tg" or "T.sub.g" or	_	
	1	degrees) and (solder same (melt\$3 or		
		heat\$3 or temperature or degrees or		
	1	reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or		
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
		(resist or photoresist))) not		
		(((semiconduct\$3 or wafer or silicon or		
	1	"Si").ti,ab. and (resist or photoresist)		
		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		
		adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		
		(438/108,115,612-615,660,694).ccls.		

			T	1 0000 /40 /07 12 25
-	126		USPAT;	2003/10/07 13:35
		benzocyclobutene or benzo adj cyclobutene	US-PGPUB;	
		or benzocyclo adj butene or benzo adj	EPO; JPO;	
		cyclo adj butene or BCB) same (transition	IBM_TDB	
		adj temperature or "Tg" or "T.sub.g" or		
		degrees) and (solder same (melt\$3 or		
		heat\$3 or temperature or degrees or		
-		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or		
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
	ļ	cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same		
		(resist or photoresist))) not		ł
		(((semiconduct\$3 or wafer or silicon or		
	j	"Si").ti,ab. and (resist or photoresist)		
		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
	İ	or degree)) and (benzocyclobutene or benzo		
		adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		
		(430/311,313-314,316-319).ccls.) or		
		(((resist or photoresist or polyimide or		
		benzocyclobutene or benzo adj cyclobutene		
		or benzocyclo adj butene or benzo adj		
		cyclo adj butene or BCB) same (transition		
		adj temperature or "Tg" or "T.sub.g" or		
		degrees) and (solder same (melt\$3 or		
		heat\$3 or temperature or degrees or		
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or		
		temperature or degree)) and		ļ
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
		(resist or photoresist))) not	İ	
		(((semiconduct\$3 or wafer or silicon or		
		"Si").ti,ab. and (resist or photoresist)		
		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		
		adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		
		(430/329-330).ccls.)) or (((resist or		
		photoresist or polyimide or		
		benzocyclobutene or benzo adj cyclobutene		
		or benzocyclo adj butene or benzo adj		
		cyclo adj butene or BCB) same (transition	1	
		adj temperature or "Tg" or "T.sub.g" or		
		degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or		
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or		
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
		(resist or photoresist))) not		
		(((semiconduct\$3 or wafer or silicon or	1	
		"Si").ti,ab. and (resist or photoresist)		
		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		
		adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		
		(438/108,115,612-615,660,694).ccls.)		
	<u></u>	<u>Lagrander de la companya de la companya de la companya de la companya de la companya de la companya de la comp</u>	***	·

- 10		USPAT;	2003/10/07 13:34
	benzocyclobutene or benzo adj cyclobutene	US-PGPUB;	
	or benzocyclo adj butene or benzo adj	EPO; JPO;	
	cyclo adj butene or BCB) same (transition	IBM_TDB	
	adj temperature or "Tg" or "T.sub.g" or		
	degrees) and (solder same (melt\$3 or		
	heat\$3 or temperature or degrees or		
	reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
	bump\$3) same (heat\$3 or thermal\$3 or		
	temperature or degree)) and		
	((benzocyclobutene or benzo adj		
	cyclobutene or benzocyclo adj butene or		
	benzo adj cyclo adj butene or BCB) same		
	(resist or photoresist))) not		
	(((semiconduct\$3 or wafer or silicon or		
	"Si").ti,ab. and (resist or photoresist)		1
	same solder\$3 near3 (ball\$3 or bump\$3)		
	same (heat\$3 or thermal\$3 or temperature		
	or degree)) and (benzocyclobutene or benzo		
	adj cyclobutene or benzocyclo adj butene		
	or BCB) same (resist or photoresist))) and		1
	(228/164,203,232,246,262.9).ccls.		
L	(220, 101, 200, 201, 210, 202.)	L	l

•	136	<pre>(((((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene</pre>	USPAT; US-PGPUB;	2003/10/07 14:1
		or benzocyclo adj butene or benzo adj	EPO; JPO;	
		cyclo adj butene or BCB) same (transition	IBM TDB	
		adj temperature or "Tg" or "T.sub.g" or	_	
		degrees) and (solder same (melt\$3 or		
	:	heat\$3 or temperature or degrees or		
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or		
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
	,	(resist or photoresist))) not		
		<pre>(((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist)</pre>		
		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		
		adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		
1		(430/311,313-314,316-319).ccls.) or		
		(((resist or photoresist or polyimide or		
		benzocyclobutene or benzo adj cyclobutene		
		or benzocyclo adj butene or benzo adj		
		cyclo adj butene or BCB) same (transition		
		adj temperature or "Tg" or "T.sub.g" or		
		degrees) and (solder same (melt\$3 or		
		heat\$3 or temperature or degrees or	1	
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or		
		temperature or degree)) and		
		((benzocyclobutene or benzo adj		
		cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
ļ		(resist or photoresist))) not		
1		(((semiconduct\$3 or wafer or silicon or		
		"Si").ti,ab. and (resist or photoresist)		İ
1		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		
		adj cyclobutene or benzocyclo adj butene		
ļ		or BCB) same (resist or photoresist))) and (430/329-330).ccls.)) or (((resist or		
		photoresist or polyimide or	i	
		benzocyclobutene or benzo adj cyclobutene		
		or benzocyclo adj butene or benzo adj		
		cyclo adj butene or BCB) same (transition		
		adj temperature or "Tg" or "T.sub.g" or		
		degrees) and (solder same (melt\$3 or		
		heat\$3 or temperature or degrees or		
		reflow\$3)) not ((solder\$3 near3 (ball\$3 or		
		bump\$3) same (heat\$3 or thermal\$3 or		
+		temperature or degree)) and		
	į	((benzocyclobutene or benzo adj		
	'	cyclobutene or benzocyclo adj butene or		
		benzo adj cyclo adj butene or BCB) same		
		(resist or photoresist))) not		
ĺ		<pre>(((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist)</pre>		
		same solder\$3 near3 (ball\$3 or bump\$3)		
		same (heat\$3 or thermal\$3 or temperature		
		or degree)) and (benzocyclobutene or benzo		
		adj cyclobutene or benzocyclo adj butene		
		or BCB) same (resist or photoresist))) and		
		(438/108,115,612-615,660,694).ccls.)) or		
		(((resist or photoresist or polyimide or		1
1		benzocyclobutene or benzo adj cyclobutene		
		or benzocyclo adj butene or benzo adj		
		cyclo adj butene or BCB) same (transition		
		adj temperature or "Tg" or "T.sub.g" or		
	ry 10	degrees) and (solder same (melt\$3 or)/N260334 x000 t26mp204raturRager Stegrees or		
arch Uid+a	_v	Andrew or war compared compared medices of	I	1
arch Histo	\	cestlows 1900 of tsp (solder\$3 near3 (ball\$3 or		